

#### **Features**

- · Heatsink design
- Schottky barrier diodes
- Low leakage current
- Solder dip 260 °C, 10 s
- Low forward voltage drop
- Low profile typical height of 1.1 mm
- Moisture sensitivity: level 1, per J-STD-020
- High temperature soldering guaranteed: 260°C/10 seconds

## **Typical Applications**

For low voltage high frequency inverters, DC/DC converters and polarity protection application.

| Maximum Ratings (TA = 25 °C unless otherwise noted)                                |                      |             |      |  |  |
|--|----------------------|-------------|------|--|--|
| Parameter  | Symbol               | SGC101BSH   | Unit |  |  |
| Maximum repetitive peak reverse voltage  | VRRM                 | 100         | V    |  |  |
| Maximum RMS voltage  | VRMS                 | 70          | V    |  |  |
| Maximum DC blocking voltage  | VDC                  | 100         | V    |  |  |
| Maximum average forward rectified current  | IF(AV) <sup>1)</sup> | 10.0        | А    |  |  |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | IFSM                 | 250         | А    |  |  |
| Operating junction and storage temperature range                                   | TJ, TSTG             | -55 to +150 | °C   |  |  |

| Electrical Characteristics (TA = 25 °C unless otherwise noted) |                     |                       |                                |      |       |  |  |
|--|---------------------|-----------------------|--------------------------------|------|-------|--|--|
| Parameter  | Test Conditions     |                       | Symbol                         | MAX. | Unit  |  |  |
| Maximum instantaneous forward voltage                          | I <sub>F</sub> =10A | T <sub>A</sub> =25°C  | V <sub>F</sub>                 | 0.8  | Volts |  |  |
|  | VR=100V             | T <sub>A</sub> =25℃   | I <sub>R</sub>                 | 50   | uA    |  |  |
| Maximum instantaneous reverse current                          |                     | T <sub>A</sub> =125°C |                                | 20   | mA    |  |  |
| Typical junction capacitance                                   | 4.0 V, 1 MHz        |                       | Cj                             | 340  | pF    |  |  |
| Typical thermal resistance                                     | juntion to mount    |                       | R <sub>0JM</sub> <sup>1)</sup> | 5    | °C/W  |  |  |

Note1)Thermal resistance R<sub>0JM</sub> is junction to mount,mounted on P.C.B with 30\*30mm copper pad area



Cathode

& Heatsink

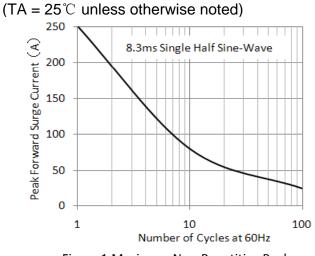
eSGC (TO-277)

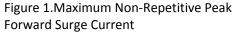
Anode 1

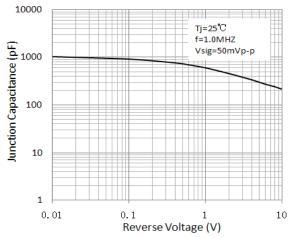
Anode 2

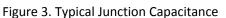


### **Ratings and Characteristics Curves**









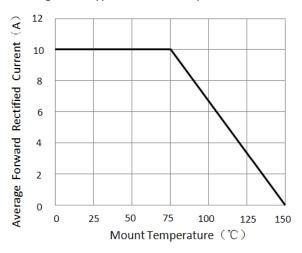
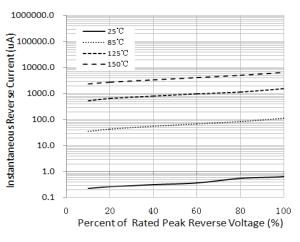
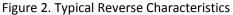


Figure 5.Forward Current Derating Curve





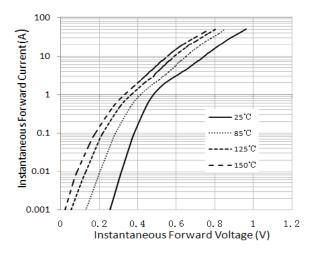
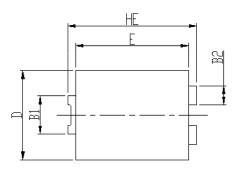


Figure 4. Typical Instantaneous Forward Characteristics

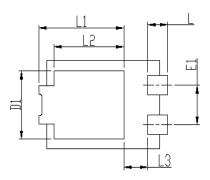


# Surface Mount Schottky Rectifier Reverse Voltage 100V Forward Current 10A

#### Package Outline Dimensions







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### Packing Information

#### Packing quantities:

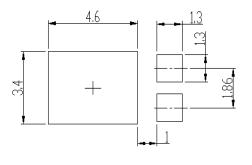
5000 pcs/Reel, 12mm Tape, 13" Reel

#### **Tape & Reel Specification**

|        | 6.8±0.1 | \$1 <sup>52</sup>   → 1   → 1   → | 1.75±0.1 |
|--------|---------|-----------------------------------|----------|
| 12±0.1 | 4       |                                   | 1.0      |
| 1      |         | 4.5±0.1                           | 5.5±0.1  |

| DIM | Unit      | mm  | Unit: inch |       |  |
|-----|-----------|-----|------------|-------|--|
|     | MIN       | MAX | MIN        | MAX   |  |
| HE  | 6.4       | 6.6 | 0.252      | 0.260 |  |
| Е   | 5.6       | 5.8 | 0.220      | 0.228 |  |
| D   | 4.1       | 4.3 | 0.161      | 0.169 |  |
| B1  | 1.7       | 1.9 | 0.067      | 0.075 |  |
| B2  | 0.8       | 1   | 0.031      | 0.039 |  |
| А   | 1.05      | 1.2 | 0.041      | 0.047 |  |
| С   | 0.3       | 0.4 | 0.012      | 0.016 |  |
| L   | 0.85      | 1.1 | 0.033      | 0.043 |  |
| L1  | 4.2       | 4.4 | 0.165      | 0.173 |  |
| L2  | 3.52 Тур. |     | 0.139 Тур. |       |  |
| L3  | 1.1       | 1.4 | 0.043      | 0.055 |  |
| D1  | 3         | 3.3 | 0.118      | 0.130 |  |
| E1  | 1.86 Typ. |     | 0.073 Typ. |       |  |

#### Soldering footprint





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